



# Iguna

## IGUNA HS, -HT, -CL, -LS

The following guide lines are a summary of steps to get the best result of bonding substrates and optimize the use of the tape. If you use a primer in combination with the tape we advise to follow the guide lines of use of the primer as well.

### Attention!

Before you connect the substrates, it is important that the substrates have been acclimatized for at least 24 hours. When choosing your workshop, it is important to take precautionary measures such as your own safety and a well-ventilated area. When applying adhesive tape preferably temperature should be between 16 degrees Celsius and 24 degrees Celsius, with a relative humidity of 30% -50%.

**The connection requires 72 hours dwell time before it reaches it final strength.**

The guidelines for applying adhesive tape are based on reliable tests and data, but can be different per situation, which cannot guarantee completeness and accuracy. It is therefore important and your own responsibility that you judge and test the bonding before using it for the intended application.

In case of inconvenience, damage, or doubt about the delivered product and / or the bonding of the substrates, it is advisable to contact us directly.

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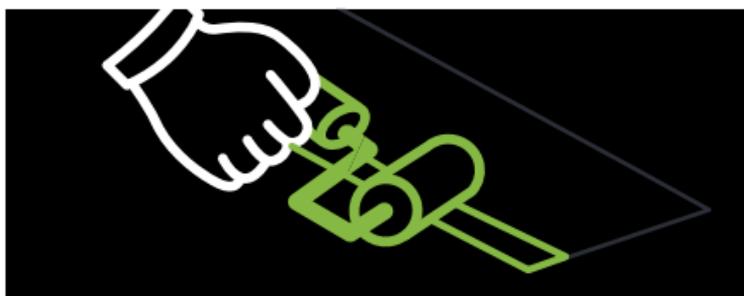
# Guidelines for applying self-adhesive tapes



When a surface is contaminated or corroded you have to sand the surface first and clean with Isopropylalcohol and a Lint-free cloth



Substrates have to be dry. Clean always in one direction and in one movement.



Apply the tape to one of the surfaces and press it well, preferably with a roller. Avoid contact with you hand to the adhesive side of the tape as well as the cleaned surfaces.



Finally connect the substrates and press them well with a pressure roller for better adhesion. Review and test the connection of the substrate before using it for the intended application.